FABRICATION AND CHARACTERIZATION OF MEMS BASED WAFER-SCALE PALLADIUM-SILVER ALLOY MEMBRANES FOR HYDROGEN SEPARATION AND HYDROGENATION/DEHYDROGENATION REACTIONS

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ABSTRACT

In this paper, a MEMS based wafer-scale palladium - silver alloy membrane (MWSPdAgM) is presented. This membrane has the potential to be used for hydrogen purification and other applications [1]. A palladium-silver alloy layer (Pd-Ag) was prepared by co-sputtering. The thin Pd-Ag alloy has high hydrogen selectivity, high permeation rate as well as high mechanical and chemical stability. Typical flow rates of 0.5 mol H₂ /m².s have been measured with a minimal selectivity of 550 for H₂/N₂. Anodic bonding of thick glass to silicon was used to package the membrane and create a very robust module. The membrane has high mechanical strength and can withstand pressures up to 4 bars at room temperature. The presented fabrication method allows the development of a module for industrial applications that consists of a stack with a large number of glass/membrane plates.

INTRODUCTION

The increased demand for hydrogen in recent years in many sectors such as petrochemical and semi-conductor processing and fuel cell applications has led to a revival of interest in methods for separation and purification of hydrogen from gas mixtures [2]. Palladium (Pd)-based membranes have been the focus of many studies, due largely to their unmatched potential as hydrogen-selective membranes for purification. A comprehensive review of Pd-based membranes and their applications has been recently been provided by R.Dittmeyer et al. [1] and by Shu et al. [3].

However, conventional technology is limited by the high cost of palladium combined with fabrication methods resulting in thick palladium films. For instance, palladium/silver metal multi-tubular assemblies having a membrane thickness of 50 µm or more have been used for many years for laboratory purification of hydrogen. The wall thickness of these tubes incorporated in such assemblies reduces the hydrogen flux and inhibits their application for larger-scale chemical production, apart from the investment cost of the precious metal.

Microtechnology is able to produce very thin Pd membranes, therewith dramatically increasing the flux efficiency of the membrane, and possibly decreasing the cost of the technology. So far, only chip-diced Pd membranes have been reported, e.g. at MEMS’ 99 [4]. In this paper, the process development of a wafer-scale separation membrane is presented. The membrane performance was also characterized with respect to mechanical strength, hydrogen flux, and selectivity.

FABRICATION

Palladium Silver Membranes on Silicon Frame

A cross-section of the PdAg membrane is shown in figure 1. It consists of a silicon wafer and two glass wafers.

Figure 1: Cross-section of the separation membrane
The process steps of the membrane are shown in figure 2. A 3 inch, (110), double side polished silicon substrate is coated with 1 µm of wet-thermally oxidized SiO2. The SiO2 coating serves as a protective layer during subsequent etching steps. It should be mentioned that, for the fabrication of high-aspect-ratio features by anisotropic etching of (110) silicon, precise alignment of the features to the (111) planes is of critical importance and was described in detail in [5,6]. First of all, fan-shaped structures are imprinted on the silicon wafer by standard photolithography, followed by removal of SiO2 in a buffered oxide etch (BHF 1:7). Afterwards, the fan-shaped structures are etched for a short time in KOH to indicate the exact <110> directions [6]. Then, narrow slits of 25 by 1250 µm are aligned to <110> directions and patterned using the steps mentioned above. The wafer is immersed in 25 % KOH solution at 75 °C to etch the silicon until ca. 50 µm is left. A similar pattern may also be obtained with Reactive Ion Etching [5]. However, with that method only one wafer at a time can be processed while several can be etched simultaneously with KOH. An alloy layer of Pd77% -Ag23% w with a thickness of 1 µm is deposited by co-sputtering [7] through a shadow mask on the bottom side of the silicon wafer, using titanium (Ti) as an adhesion layer. In our study, PdAg is used as separation element because it has shown higher resistance to hydrogen embrittlement than pure Pd [8]. Next, KOH is used to etch silicon in the trenches until the SiO2 layer is reached. Finally, this oxide layer and the Ti are removed in BHF to reveal the back surface of the Pd-Ag membranes. The supported silicon structures and the membrane are shown in figure 3 and figure 4.

Flow Channels in Glass

A powder blasting technique, which has been developed in our lab [9], was used to create a flow channel of 1 mm depth on each of two 5 mm thick glass wafers. The flow channel is then connected to the outer world by four previous drilled holes within the glass wafers. A picture of the flow channels is shown in figure 5.

Assembly of Wafer Module

Finally, the silicon wafer is bonded between the two thick glass wafers by a four-electrode anodic bonding technique (see figure 6). The process is performed in two steps, because adequate bonding requires that a positive electrical voltage be applied to the silicon and a negative voltage to the glass. This process results in a tight seal between each glass wafer and the silicon wafer.

A stainless steel membrane holder was developed and is presented in figure 7. In the design, graphite rings are used to make a gas-tight connection.

RESULTS AND DISCUSSION

Preliminary tests showed that the PdAg membranes do not break at a pressure difference of 4 bars between the two sides of the membrane. This is much higher than expected on the basis of literature data for bulk Pd[10].

Figure 2: Fabrication process of the membrane
To determine hydrogen permeation and selectivity of the membranes, they were positioned in the stainless steel membrane holder and heated up to elevated temperatures. Next, the membrane permeability and selectivity for hydrogen were determined as a function of the hydrogen partial pressure (0–0.3 bar), and temperature (350–450°C). During these experiments the retentate and permeate sides of the membrane were continuously flushed at atmospheric pressure, the retentate side with a mixture of hydrogen and helium, the permeate side with pure nitrogen. The flux and selectivity were determined by measuring the hydrogen and helium concentration in the nitrogen stream with a gas chromatograph, equipped with a Thermal Conductivity Detector (TCD).

The hydrogen flow rate through the membrane versus a duration of the experiment is given in figure 8. It should be noted that the measurement started when the membrane temperature was at 350°C. At an average membrane temperature of 450°C, hydrogen flux of 0.5 mol H₂/m².s was achieved.

Moreover, dependence of hydrogen flux on temperature was also investigated. Figure 9 shows the hydrogen flow rates through the membrane at different temperatures from 350°C to 450°C. As can be seen that hydrogen flow rate increases with increasing temperature. However, the dependence is stronger than expected by theory [11]. More experiments are needed to be done to have better understanding of the membrane characterizations.

From the measured data, a minimal separation factor of 550 for hydrogen to nitrogen was calculated. The final determination of selectivity was limited by the sensitivity of our equipments.

**CONCLUSIONS**

MEMS based wafer-scale palladium - silver alloy membranes were fabricated and tested. Anodic bonding of thick glass to silicon was used to package the membrane and create the very robust module.
The membranes have high mechanical strength and are capable of withstanding pressure difference of 4 bars at room temperature. The palladium–silver membranes achieve high hydrogen selectivity and high permeation rate. Typical flow rates of 0.5 mol H₂/m².s are measured with the minimal selectivity of 550 for H₂/N₂. The reported palladium-silver alloy membranes can be used for hydrogen separation or purification from gas mixture or other industrial applications [1,2,3].

The results indicate that an industrial module that consists of a stack of a number of glass/membrane plates with a higher throughput of hydrogen becomes feasible.

ACKNOWLEDGEMENTS

The STW foundation is kindly acknowledged for financial support. Our thanks are also due to the entire staff of MESA’, University of Twente, for technical support. H.Wensink graciously provided help with the powder blasting.

REFERENCES